

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	377	(argon or ar) with (rapid near thermal near annealing or rta)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/25 11:50
L2	63909	(polish\$3) with (wafer or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/25 11:50
L3	71	1 and 2	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/25 11:50
L4	1979	(oxidation) with (rapid near thermal or rta)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/25 11:55
L5	34	3 and 4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/25 11:51
L6	6	5 and (smooth\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/25 11:52
L7	1614	(second) near3 (rapid near thermal or rta)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/25 11:56
L8	6	((second) near3 (rapid near thermal or rta)) with (polish\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/25 11:57
L9	5	8 and (argon or ar)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/25 11:58

L10	5	9 and (polish\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/25 11:59
L11	4	10 and (polish\$3) with (rta or thermal near annealing)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/25 12:03
L12	1	11 and (oxidation) same (rapid near thermal or rta)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/25 12:03